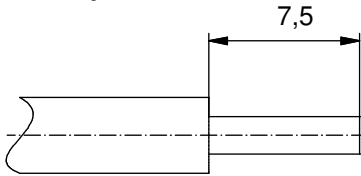


Stripping Dimensions/
Kabelvorbereitung:



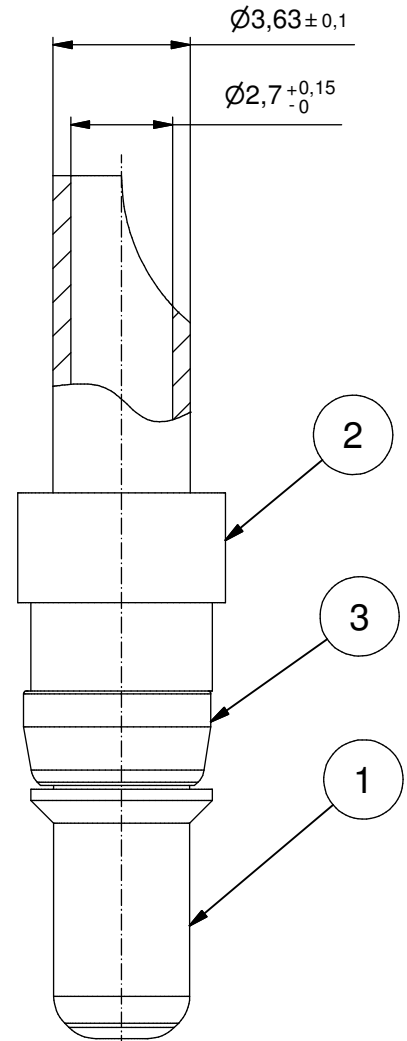
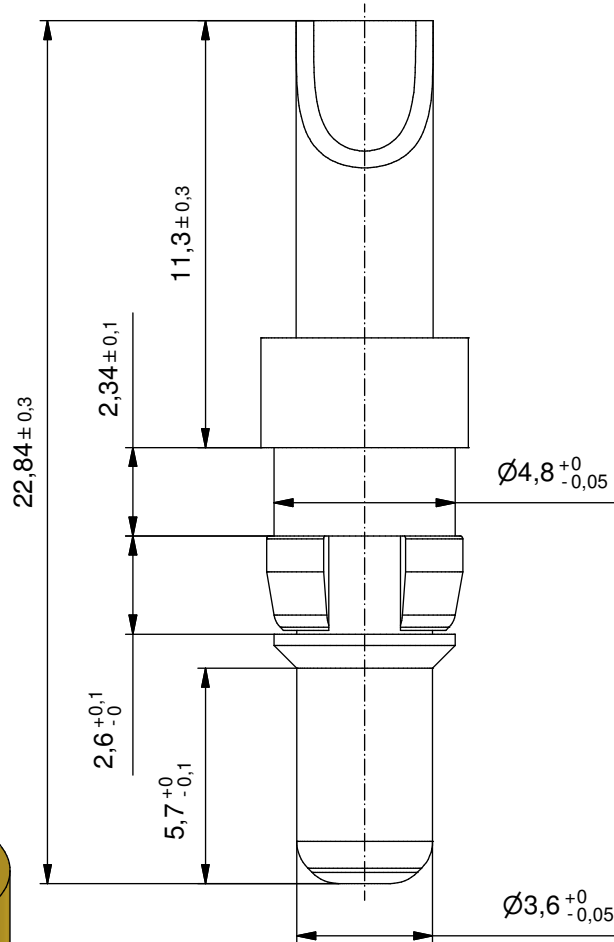
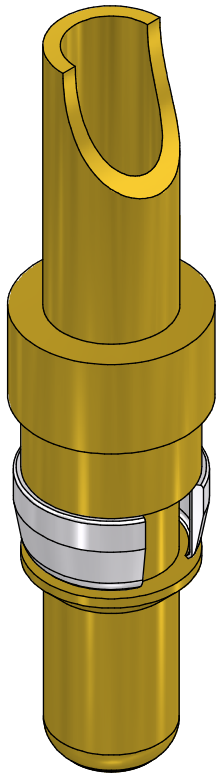
Materials/
Werkstoffe:

Contact/
Kontakt:

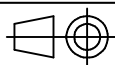
Cu alloy, Au over Ni

Retaining ring/
Haltering:

Cu alloy, Ni



Part no. / Art.-Nr.:	Plating Pos. 1/ Veredelung Pos. 1:	Plating Pos. 2/ Veredelung Pos. 2:	Plating Pos. 3/ Veredelung Pos. 3:
131A10029X	Gold Flash over Nickel Gold über Nickel	Gold over Nickel Gold über Nickel	Nickel plated/ vernickelt
131C10029X	min. 30 µm hard Gold over min. 50 µm Nickel min. 30 µm Gold über min. 50 µm Nickel	Gold over Nickel Gold über Nickel	Nickel plated/ vernickelt
131J10029X	min. 50 µm hard Gold over min. 50 µm Nickel min. 50 µm Gold über min. 50 µm Nickel	Gold over Nickel Gold über Nickel	Nickel plated/ vernickelt



dim. in mm

general tolerance/
Allgemeintoleranz:

ISO 2768-m

Index: b Ä6278 17.08.16 K.H.

Status: InBearbeitung

RoHS & REACH compliant/konform

scale/Maßstab:

5:1

	Date/Datum	Name
drawn/ gez.	17.08.16	Henneboel
appd./ gepr.	17.08.16	Koch

CONEC®

dwg no /
Z.-nr.:

13K1A5266

High power contact male
Solder cup 20 A for AWG 12-14

Hochstromkontaktstift
Lötkehl 20 A für AWG 12-14

DIN-
A4

1 / 1

Mouser Electronics

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